

# Global Wafer Dicing Saw Blades Supply, Demand and Key Producers, 2023-2029

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## Abstracts

The global Wafer Dicing Saw Blades market size is expected to reach \$ million by 2029, rising at a market growth of % CAGR during the forecast period (2023-2029).

A Wafer Dicing Saw Blade, also referred to as a diamond dicing blade or simply a dicing blade, is a cutting tool specifically designed for separating wafers into individual chips or devices in the semiconductor industry. These blades are typically made of a metal core with diamond particles embedded in a resin or metal bond.

This report studies the global Wafer Dicing Saw Blades production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for Wafer Dicing Saw Blades, and provides market size (US\$ million) and Year-over-Year (YoY) Growth, considering 2022 as the base year. This report explores demand trends and competition, as well as details the characteristics of Wafer Dicing Saw Blades that contribute to its increasing demand across many markets.

Highlights and key features of the study

Global Wafer Dicing Saw Blades total production and demand, 2018-2029, (K Units)

Global Wafer Dicing Saw Blades total production value, 2018-2029, (USD Million)

Global Wafer Dicing Saw Blades production by region & country, production, value, CAGR, 2018-2029, (USD Million) & (K Units)

Global Wafer Dicing Saw Blades consumption by region & country, CAGR, 2018-2029 & (K Units)

U.S. VS China: Wafer Dicing Saw Blades domestic production, consumption, key domestic manufacturers and share

Global Wafer Dicing Saw Blades production by manufacturer, production, price, value and market share 2018-2023, (USD Million) & (K Units)

Global Wafer Dicing Saw Blades production by Type, production, value, CAGR, 2018-2029, (USD Million) & (K Units)

Global Wafer Dicing Saw Blades production by Application production, value, CAGR, 2018-2029, (USD Million) & (K Units).

This reports profiles key players in the global Wafer Dicing Saw Blades market based on the following parameters – company overview, production, value, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include DISCO, Tokyo Seimitsu, Advanced Dicing Technologies (ADT), Loadpoint, Kulicke and Soffa Industries, Asahi Diamond Industrial, Norton Winter (Saint-Gobain), EHWA and Thermocarbon, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals, COVID-19 and Russia-Ukraine War Influence.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World Wafer Dicing Saw Blades market.

Detailed Segmentation:

Each section contains quantitative market data including market by value (US\$ Millions), volume (production, consumption) & (K Units) and average price (US\$/Unit) by manufacturer, by Type, and by Application. Data is given for the years 2018-2029 by year with 2022 as the base year, 2023 as the estimate year, and 2024-2029 as the forecast year.

Global Wafer Dicing Saw Blades Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

#### Global Wafer Dicing Saw Blades Market, Segmentation by Type

Hubless Dicing Blades

Hubbed Dicing Blades

#### Global Wafer Dicing Saw Blades Market, Segmentation by Application

Semiconductor

LED

Photovoltaic

Others

#### Companies Profiled:

DISCO

Tokyo Seimitsu

Advanced Dicing Technologies (ADT)

Loadpoint

Kulicke and Soffa Industries

Asahi Diamond Industrial

Norton Winter (Saint-Gobain)

EHWA

Thermocarbon

Kulicke and Soffa Industries

UKAM Industrial Superhard Tools

Ceiba Technologies

GI Tech

Zhengzhou Hongtuo Superabrasive Products

Shanghai Sinyang Semiconductor Materials

System Technology (Shenzhen)

Zhengzhou Qisheng Precision Manufacturing

## Key Questions Answered

1. How big is the global Wafer Dicing Saw Blades market?
2. What is the demand of the global Wafer Dicing Saw Blades market?
3. What is the year over year growth of the global Wafer Dicing Saw Blades market?

4. What is the production and production value of the global Wafer Dicing Saw Blades market?
5. Who are the key producers in the global Wafer Dicing Saw Blades market?
6. What are the growth factors driving the market demand?

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